Silicon N Channel MOS FET High Speed Power Switching

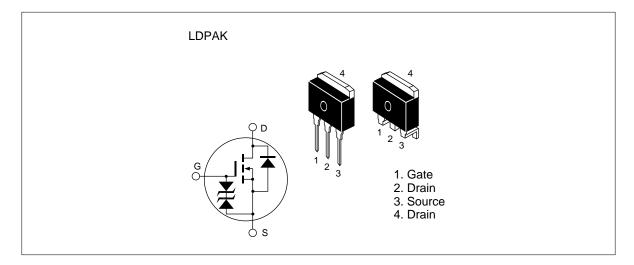
# HITACHI

ADE-208-760(Z) Target Specification, 1st. Edition Dec. 1, 1998

#### Features

- Low on-resistance
  - $R_{\text{DS}}$  =35m  $\Omega$  typ.
- High speed switching
- 4V gate drive device can be driven from 5V source

#### Outline



### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Ratings	Unit	
Drain to source voltage	V <sub>DSS</sub>	150	V	
Gate to source voltage	V <sub>GSS</sub>	±20	V	
Drain current	I <sub>D</sub>	30	A	
Drain peak current	Note1 D(pulse)	120	A	
Body-drain diode reverse drain current	I <sub>DR</sub>	30	A	
Avalanche current	AP Note3	30	A	
Avalanche energy	E <sub>AR</sub> <sup>Note3</sup>	67	mJ	
Channel dissipation	Pch Note2	100	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Note: 1.  $PW \le 10\mu s$ , duty cycle  $\le 1 \%$ 

2. Value at Tc =  $25^{\circ}C$ 

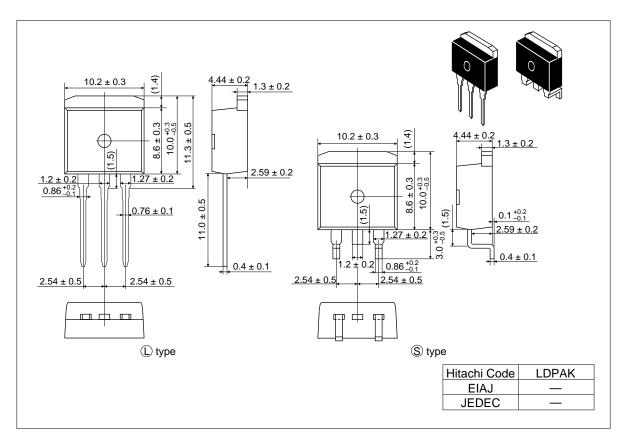
3. Value at Tch =  $25^{\circ}$ C, Rg  $\geq 50\Omega$ 

#### **Electrical Characteristics** (Ta = 25°C)

Item	Symbol	Min	Тур	Мах	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	150	_		V	$I_{\rm D} = 10 {\rm mA}, V_{\rm GS} = 0$
Gate to source breakdown voltage	V <sub>(BR)GSS</sub>	±20	—		V	$I_{g} = \pm 100 \mu A, V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>			±10	μA	$V_{GS} = \pm 16V, V_{DS} = 0$
Zero gate voltege drain current	I <sub>DSS</sub>		_	10	μA	$V_{\rm DS} = 150 \ {\rm V}, \ {\rm V}_{\rm GS} = 0$
Gate to source cutoff voltage	V <sub>GS(off)</sub>	1.0	—	2.5	V	$I_{\rm D} = 1$ mA, $V_{\rm DS} = 10$ V
Static drain to source on state	R <sub>DS(on)</sub>		35	45	mΩ	$I_{\rm D} = 15$ A, $V_{\rm GS} = 10 V^{\rm Note4}$
resistance	R <sub>DS(on)</sub>		42	75	mΩ	$I_{\rm D} = 15$ A, $V_{\rm GS} = 4$ V <sup>Note4</sup>
Forward transfer admittance	y <sub>fs</sub>	18	30		S	$I_{\rm D} = 15$ A, $V_{\rm DS} = 10 V^{\rm Note4}$
Input capacitance	Ciss		2600		pF	V <sub>DS</sub> = 10V
Output capacitance	Coss		820	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss		350	_	pF	f = 1MHz
Turn-on delay time	t <sub>d(on)</sub>		25		ns	I <sub>D</sub> = 15A, V <sub>GS</sub> = 10V
Rise time	t,		180	_	ns	$R_{L} = 2\Omega$
Turn-off delay time	$t_{d(off)}$		600		ns	_
Fall time	t <sub>f</sub>	_	280	_	ns	_
Body-drain diode forward voltage	V <sub>DF</sub>		0.95	_	V	$I_{\rm F} = 30$ A, $V_{\rm GS} = 0$
Body–drain diode reverse recovery time	t <sub>rr</sub>		110		ns	I <sub>F</sub> = 30A, V <sub>GS</sub> = 0 diF/ dt =50A/μs

Note: 4. Pulse test

### Package Dimensions (Unit: mm)



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